IGBT - Short-Circuit Rated

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Non–Punch Through (NPT) Trench construction, and provides superior performance in demanding switching applications. Offering both low on state voltage and minimal switching loss, the IGBT is well suited for motor drive control and other hard switching applications.

Features

- Low Saturation Voltage Resulting in Low Conduction Loss
- Low Switching Loss in Higher Frequency Applications
- 5 µs Short Circuit Capability
- Excellent Current versus Package Size Performance Density
- This is a Pb-Free Device

Typical Applications

- White Goods Appliance Motor Control
- General Purpose Inverter
- AC and DC Motor Control

ABSOLUTE MAXIMUM RATINGS

Symbol	Value	Unit
V _{CES}	650	V
I _C	30 15	А
I _{CM}	120	Α
V_{GE}	±20	V
P _D	117 47	W
t _{SC}	5	μs
T _J	-55 to +150	°C
T _{stg}	-55 to +150	°C
T _{SLD}	260	°C
	VCES IC ICM VGE PD tsc TJ Tstg	V _{CES} 650 I _C 30 15 I _{CM} 120 V _{GE} ±20 P _D 117 47 t _{SC} 5 T _J -55 to +150 T _{stg} -55 to +150

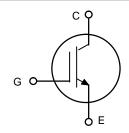
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

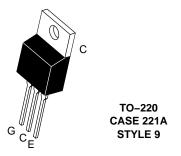


ON Semiconductor®

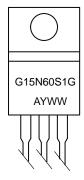
www.onsemi.com

15 A, 650 V V_{CEsat} = 1.5 V





MARKING DIAGRAM



A = Assembly Location
Y = Year
WW = Work Week
G = Pb-Free Package

ORDERING INFORMATION

Device	Package	Shipping
NGTG15N60S1EG	TO-220 (Pb-Free)	50 Units / Rail

THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal resistance junction to case, for IGBT	$R_{ heta JC}$	1.06	°C/W
Thermal resistance junction to ambient	$R_{ heta JA}$	60	°C/W

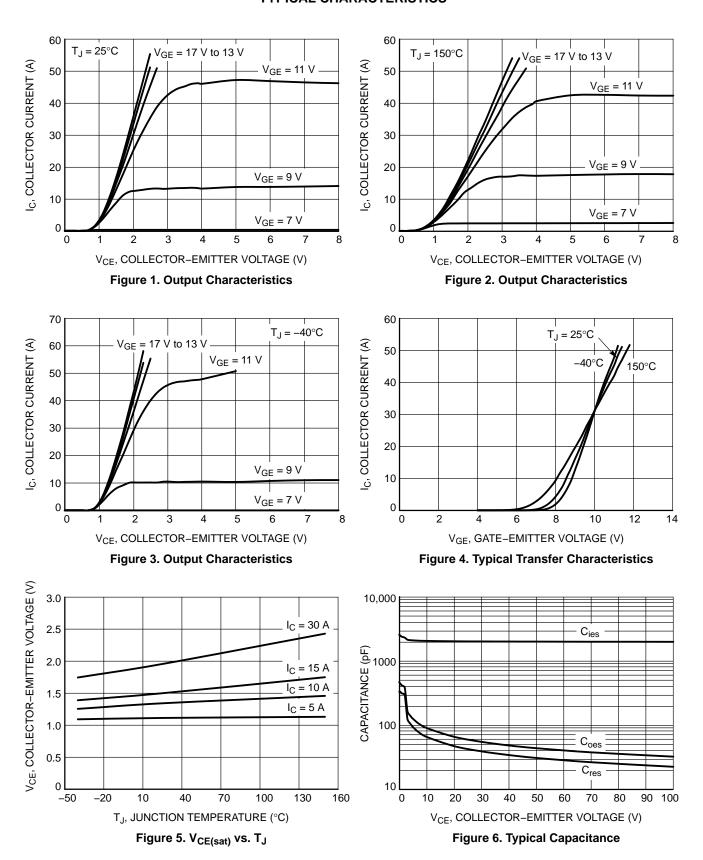
ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit	
STATIC CHARACTERISTIC							
Collector–emitter breakdown voltage, gate–emitter short–circuited	$V_{GE} = 0 \text{ V}, I_C = 500 \mu\text{A}$	V _{(BR)CES}	650	_	_	V	
Collector-emitter saturation voltage	V _{GE} = 15 V , I _C = 15 A V _{GE} = 15 V , I _C = 15 A, T _J = 150°C	V _{CEsat}	1.3 1.55	1.5 1.75	1.7 1.95	V	
Gate-emitter threshold voltage	V_{GE} = V_{CE} , I_{C} = 250 μA	V _{GE(th)}	4.5	5.5	6.5	V	
Collector-emitter cut-off current, gate-emitter short-circuited	V _{GE} = 0 V, V _{CE} = 600 V V _{GE} = 0 V, V _{CE} = 600 V, T _J = 150°C	I _{CES}	_	10 -	_ 200	μΑ	
Gate leakage current, collector–emitter short–circuited	$V_{GE} = 20 \text{ V}, V_{CE} = 0 \text{ V}$	I _{GES}	_	-	100	nA	
Forward Transconductance	$V_{CE} = 20 \text{ V}, I_{C} = 15 \text{ A}$	9fs	-	10.1	-	S	
DYNAMIC CHARACTERISTIC							
Input capacitance		C _{ies}	-	1950	-		
Output capacitance	$V_{CE} = 20 \text{ V}, V_{GE} = 0 \text{ V}, f = 1 \text{ MHz}$	C _{oes}	-	70	-	pF	
Reverse transfer capacitance		C _{res}	-	48	-		
Gate charge total		Q_{g}	-	88	-		
Gate to emitter charge	$V_{CE} = 480 \text{ V}, I_{C} = 15 \text{ A}, V_{GE} = 15 \text{ V}$	Q _{ge}	-	16	-	nC	
Gate to collector charge		Q _{gc}	-	42	-		
SWITCHING CHARACTERISTIC , INDUCTIVE	LOAD						
Turn-on delay time		t _{d(on)}	-	65	-		
Rise time		t _r	-	28	-		
Turn-off delay time	T _J = 25°C	t _{d(off)}	-	170	-	ns	
Fall time	$V_{CC} = 400 \text{ V, } I_{C} = 15 \text{ A}$ $R_{a} = 22 \Omega$	t _f	-	140	-		
Turn-on switching loss	$R_g = 22 \Omega$ $V_{GE} = 0 V / 15 V^*$	E _{on}	-	0.550	-		
Turn-off switching loss		E _{off}	-	0.350	-	mJ	
Total switching loss		E _{ts}	-	0.900	-		
Turn-on delay time		t _{d(on)}	-	65	-		
Rise time		t _r	-	28	-	20	
Turn-off delay time	T _J = 150°C	t _{d(off)}	-	180	-	ns	
Fall time	$V_{CC} = 400 \text{ V, } I_{C} = 15 \text{ A}$ $R_{\alpha} = 22 \Omega$	t _f	-	260	-		
Turn-on switching loss	$R_g = 22 \Omega$ $V_{GE} = 0 V / 15 V^*$	E _{on}	-	0.650	-		
Turn-off switching loss		E _{off}	-	0.600	-	mJ	
Total switching loss		E _{ts}	-	1.250	-		

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

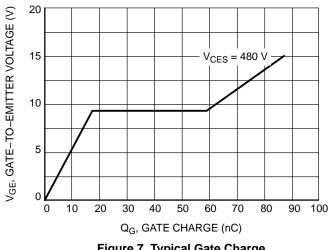
*Includes diode reverse recovery loss using NGTB15N60S1EG.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

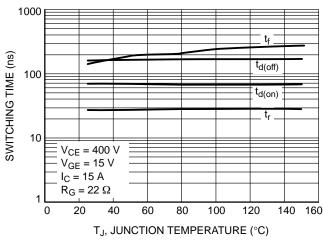
0.7



Eon 0.6 SWITCHING LOSS (mJ) 0.5 Eoff 0.4 0.3 V_{CE} = 400 V 0.2 $V_{GE} = 15 V$ $I_{C} = 15 A$ 0.1 $R_G = 22 \Omega$ 0 0 20 40 60 80 100 120 140 160 T_J, JUNCTION TEMPERATURE (°C)

Figure 7. Typical Gate Charge

Figure 8. Switching Loss vs. Temperature



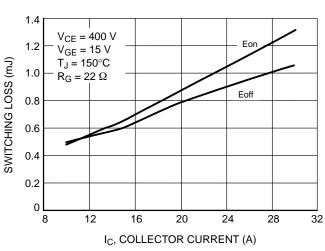
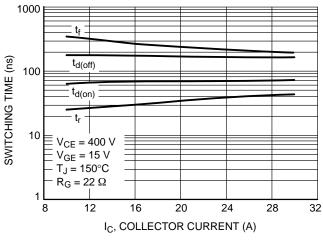


Figure 9. Switching Time vs. Temperature

Figure 10. Switching Loss vs. I_C



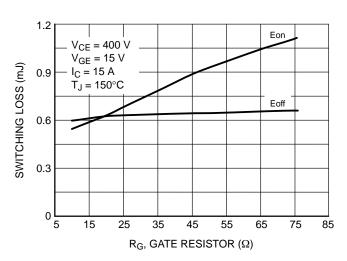


Figure 11. Switching Time vs. I_C

Figure 12. Switching Time vs. R_G

TYPICAL CHARACTERISTICS

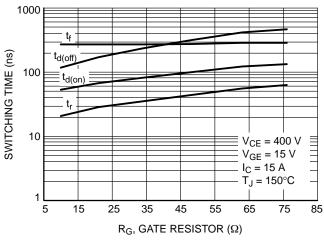


Figure 13. Switching Time vs. R_G

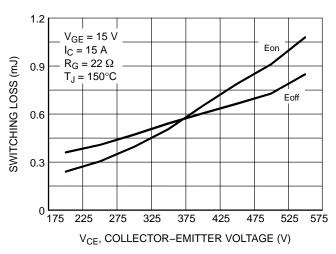


Figure 14. Switching Loss vs. V_{CE}

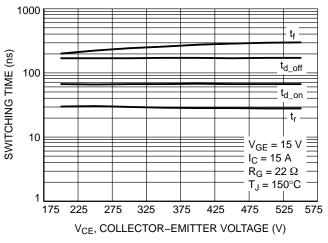


Figure 15. Switching Time vs. V_{CE}

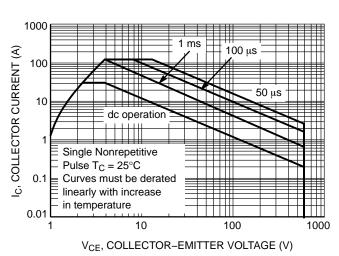


Figure 16. Safe Operating Area

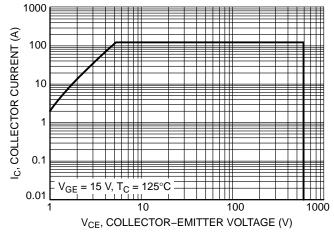


Figure 17. Reverse Bias Safe Operating Area

TYPICAL CHARACTERISTICS

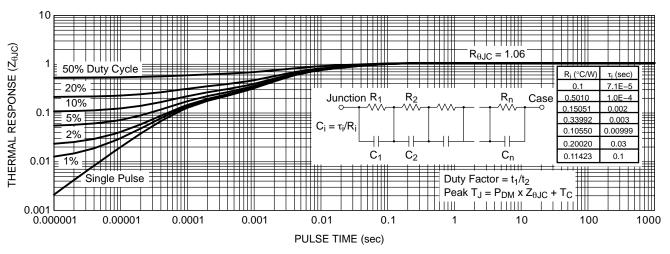


Figure 18. IGBT Transient Thermal Impedance

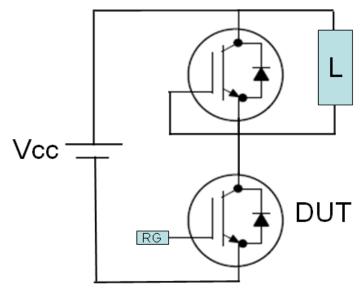


Figure 19. Test Circuit for Switching Characteristics

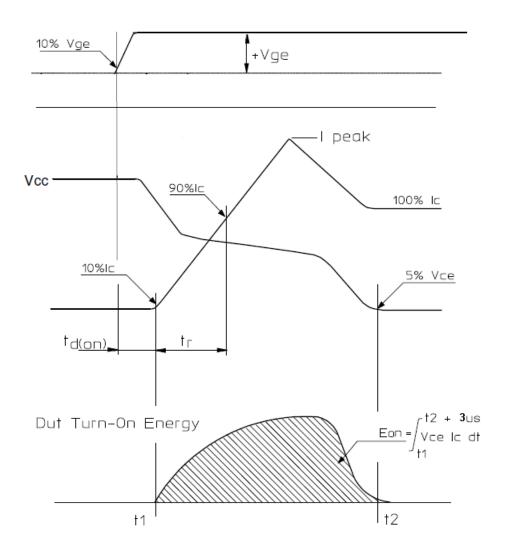


Figure 20. Definition of Turn On Waveform

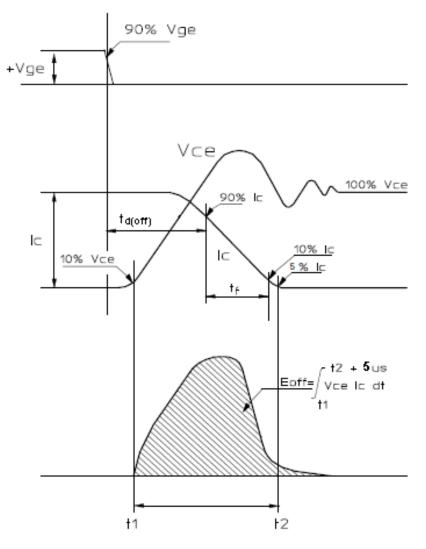
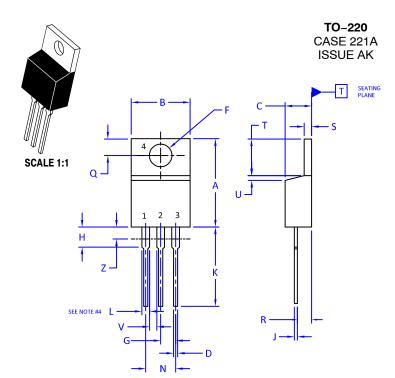


Figure 21. Definition of Turn Off Waveform





DATE 13 JAN 2022

NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 2009.
- 2. CONTROLLING DIMENSION: INCHES
- 3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

4. MAX WIDTH FOR F102 DEVICE = 1.35MM

	INCHES		MILLIMETERS	
DIM	MIN.	MAX.	MIN.	MAX.
Α	0.570	0.620	14.48	15.75
В	0.380	0.415	9.66	10.53
С	0.160	0.190	4.07	4.83
D	0.025	0.038	0.64	0.96
F	0.142	0.161	3.60	4.09
G	0.095	0.105	2.42	2.66
Н	0.110	0.161	2.80	4.10
J	0.014	0.024	0.36	0.61
К	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.41
T	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
V	0.045		1.15	
Z		0.080		2.04

STYLE 1: PIN 1. 2. 3. 4.	COLLECTOR EMITTER	STYLE 2: PIN 1. 2. 3. 4.	EMITTER COLLECTOR	STYLE 3: PIN 1. 2. 3. 4.	ANODE	2. 3.	MAIN TERMINAL 1 MAIN TERMINAL 2 GATE MAIN TERMINAL 2
STYLE 5: PIN 1. 2. 3. 4.	DRAIN SOURCE	2. 3.	ANODE CATHODE ANODE CATHODE	STYLE 7: PIN 1. 2. 3. 4.	ANODE	2. 3.	CATHODE ANODE EXTERNAL TRIP/DELAY ANODE
STYLE 9: PIN 1. 2. 3. 4.		STYLE 10: PIN 1. 2. 3. 4.	GATE	STYLE 11: PIN 1. 2. 3. 4.	DRAIN	STYLE 12: PIN 1. 2. 3. 4.	

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